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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE
(213.003-D3-US)

In re Application of: **Ye et al.**

Serial No: **10/763,433**

Filed: **January 23, 2004**

Title: **Method and Apparatus for Monitoring
Integrated Circuit Fabrication**

) Group Art Unit: **2857**

) Examiner:


Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Certificate of Mailing under 37 CFR 1.8

I hereby certify that the attached Statement of Related Applications (1 page) is being deposited with the United States Postal Service with sufficient postage as first class mail in an envelope addressed to:

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on May 17, 2004.



Signature



Print Name of Person Signing Certificate



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STATEMENT OF RELATED APPLICATIONS

Dear Sir:

The above-referenced application is related to the following applications which all claim priority to "Method and Apparatus for Monitoring Integrated Circuit Fabrication", Serial No. 10/677,563, filed October 2, 2003:

1. "Method and Apparatus for Monitoring Integrated Circuit Fabrication",
Serial No. 10/756,718, filed January 13, 2004 (still pending); and
2. "Method and Apparatus for Monitoring Integrated Circuit Fabrication",
Serial No. 10/763,142, filed January 22, 2004 (still pending).

Respectfully submitted,

Date: May 17, 2004

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